SN54ACT533, SN74ACT533 OCTAL TRANSPARENT D-TYPE LATCHES WITH 3-STATE OUTPUTS

SCAS553C - NOVEMBER 1995 - REVISED OCTOBER 2002

- 4.5-V to 5.5-V V_{CC} Operation
- Inputs Accept Voltages to 5.5 V
- Max t_{pd} of 11 ns at 5 V
- Inputs Are TTL-Voltage Compatible
- 3-State Inverting Outputs Drive Bus Lines Directly

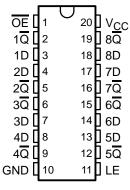
description/ordering information

The 'ACT533 devices are octal transparent D-type latches with 3-state outputs. When the latch-enable (LE) input is high, the $\overline{\mathbb{Q}}$ outputs follow the complements of the data (D) inputs. When LE is taken low, the $\overline{\mathbb{Q}}$ outputs are latched at the inverted levels set up at the D inputs.

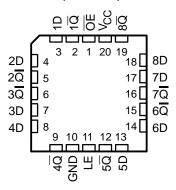
A buffered output-enable (\overline{OE}) input can be used to place the eight outputs in either a normal logic state (high or low logic levels) or the high-impedance state. In the high-impedance state, the outputs neither load nor drive the bus lines significantly. The high-impedance state and increased drive provide the capability to drive bus lines without need for interface or pullup components.

OE does not affect the internal operations of the latches. Old data can be retained or new data can be entered while the outputs are in the high-impedance state.

SN54ACT533 . . . J OR W PACKAGE SN74ACT533 . . . DB, DW, N, NS, OR PW PACKAGE (TOP VIEW)



SN54ACT533 . . . FK PACKAGE (TOP VIEW)



To ensure the high-impedance state during power up or power down, \overline{OE} should be tied to V_{CC} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

ORDERING INFORMATION

TA	PACKAGI	ΕŢ	ORDERABLE PART NUMBER	TOP-SIDE MARKING
	PDIP – N	Tube	SN74ACT533N	SN74ACT533N
	SOIC - DW	Tube	SN74ACT533DW	ACT533
-40°C to 85°C	30IC - DW	Tape and reel	SN74ACT533DWR	AC1555
-40 C to 65 C	SOP - NS	Tape and reel	SN74ACT533NSR	ACT533
	SSOP – DB Tape and reel		SN74ACT533DBR	AD533
	TSSOP – PW	Tape and reel	SN74ACT533PWR	AD533
	CDIP – J	Tube	SNJ54ACT533J	SNJ54ACT533J
–55°C to 125°C	CFP – W	Tube	SNJ54ACT533W	SNJ54ACT533W
	LCCC – FK	Tube	SNJ54ACT533K	SNJ54ACT533FK

[†] Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.



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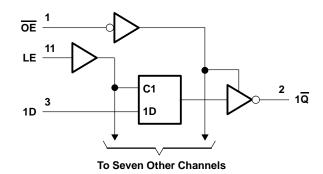


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FUNCTION TABLE (each latch)

	INPUTS							
OE	LE	D	Q					
L	Н	Н	L					
L	Н	L	Н					
L	L	Χ	\overline{Q}_0					
Н	X	Χ	Z					

logic diagram (positive logic)



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, V _{CC}		–0.5 V to 7 V
Input voltage range, V _I (see Note 1)		
Output voltage range, VO (see Note 1)		–0.5 V to V_{CC} + 0.5 V
Input clamp current, I_{IK} ($V_I < 0$ or $V_I > V_{CC}$)		±20 mA
Output clamp current, I _{OK} (V _O < 0 or V _O > V _{CO}	c)	±20 mA
Continuous output current, I_O ($V_O = 0$ to V_{CC})	- 	±50 mA
Continuous current through V _{CC} or GND		±200 mA
Package thermal impedance, θ_{JA} (see Note 2):	: DB package	70°C/W
	DW package	58°C/W
	N package	69°C/W
	NS package	60°C/W
	PW package	83°C/W
Storage temperature range, T _{stq}		–65°C to 150°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.
 - 2. The package thermal impedance is calculated in accordance with JESD 51-7.



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recommended operating conditions (see Note 3)

		SN54A	CT533	SN74A	CT533	UNIT
		MIN	MAX	MIN	MAX	UNII
Vсс	Supply voltage	4.5	5.5	4.5	5.5	V
VIH	High-level input voltage	2	3	2		V
V _{IL}	Low-level input voltage		0.8		0.8	V
٧ _I	Input voltage	0	Vcc	0	VCC	V
۷o	Output voltage	0	Vcc	0	Vcc	V
loh	High-level output current	2	-24		-24	mA
l _{OL}	Low-level output current	70/	24		24	mA
Δt/Δν	Input transition rise or fall rate	Q	8		8	ns/V
TA	Operating free-air temperature	-55	125	-40	85	°C

NOTE 3: All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

DADAMETED	TEST SOMBITIONS	, , , , , , , , , , , , , , , , , , ,	T,	_A = 25°C	;	SN54A	CT533	SN74A	CT533	
PARAMETER	TEST CONDITIONS	Vcc	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNIT
	Jan = 50 uA	4.5 V	4.4	4.49		4.4		4.4		
	I _{OH} = -50 μA	5.5 V	5.4	5.49		5.4		5.4		
\/a	1011 = 24 mA	4.5 V	3.86			3.7		3.76		V
VOH	I _{OH} = -24 mA	5.5 V	4.86			4.7		4.76		V
	I _{OH} = -50 mA [†]	5.5 V				3.85				
	$I_{OH} = -75 \text{ mA}^{\dagger}$	5.5 V					3	3.85		
	I _{OL} = 50 μA	4.5 V			0.1		0.1		0.1	
	ΙΟΣ = 30 μΑ	5.5 V			0.1		0.1		0.1	
V _{OL}	I _{OL} = 24 mA	4.5 V			0.36	4	0.5		0.44	V
VOL	IOL - 24 IIIA	5.5 V			0.36	27/	0.5		0.44	V
	I _{OL} = 50 mA [†]	5.5 V				70	1.65			
	I _{OL} = 75 mA [†]	5.5 V				10			1.65	
loz	$V_O = V_{CC}$ or GND	5.5 V			±0.25		±5		±2.5	μΑ
Ι _Ι	$V_I = V_{CC}$ or GND	5.5 V			±0.1		±1		±1	μΑ
Icc	$V_I = V_{CC}$ or GND, $I_O = 0$	5.5 V			4		80		40	μΑ
Δlcc [‡]	One input at 3.4 V, Other inputs at GND or V _{CC}	5.5 V		0.6			1.6		1.5	mA
C _i	$V_I = V_{CC}$ or GND	5 V		4.5					·	pF

Not more than one output should be tested at a time, and the duration of the test should not exceed 2 ms.

timing requirements over recommended operating free-air temperature range, V_{CC} = 5 V \pm 0.5 V (unless otherwise noted) (see Figure 1)

		$T_A = 2$	T _A = 25°C		CT533	SN74ACT533		UNIT
		MIN	MAX	MIN	MAX	MIN	MAX	UNIT
t _W	Pulse duration, LE high	5		7.5	100	6		ns
t _{su}	Setup time, data before LE↓	3		5.5	11/2	4		ns
t _h	Hold time, data after LE↓	2		4		2.5		ns



[‡] This is the increase in supply current for each input that is at one of the specified TTL voltage levels, rather than 0 V or V_{CC}.

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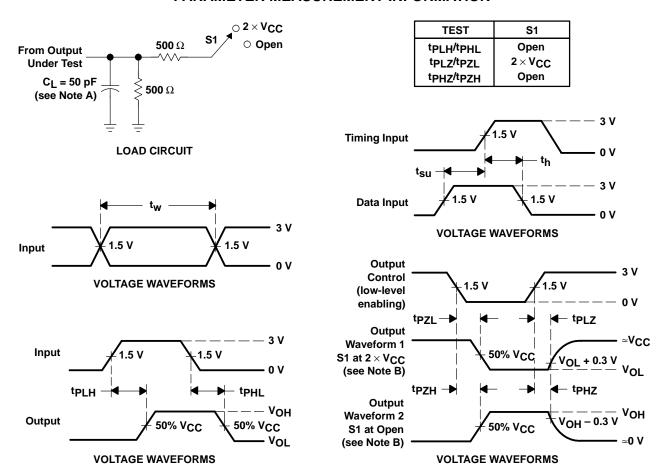
switching characteristics over recommended operating free-air temperature range, V_{CC} = 5 V \pm 0.5 V (unless otherwise noted) (see Figure 1)

PARAMETER	FROM	ТО	T _A = 25°C		SN54A	CT533	SN74ACT533		UNIT
FARAIMETER	(INPUT)	(OUTPUT)	MIN	MAX	MIN	MAX	MIN	MAX	UNIT
^t PLH	D	ρl	2.5	10.5	1.5	13	2	11.5	ns
^t PHL	D	I ^Q [2.5	10	1.5	12.5	2	11	115
^t PLH	LE	lα		10.5	1.5	13	2	11.5	ns
^t PHL	LE	y	2.5	10.5	1.5	13	2	11.5	115
^t PZH	<u>OE</u>	ρl	2	10	(ب	12.5	1.5	11	ns
^t PZL	ÜE	σ	2	10)1 (C	12.5	1.5	11	115
^t PHZ	ŌĒ	Θ	2	10	Ø 1	12.5	1.5	11	ns
^t PLZ	OE	Q	2	10	1	12.5	1.5	11	115

operating characteristics, $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$

	PARAMETER	TEST CO	TYP	UNIT	
C _{pd}	Power dissipation capacitance	C _L = 50 pF,	f = 1 MHz	40	pF

PARAMETER MEASUREMENT INFORMATION



NOTES: A. C_L includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR \leq 1 MHz, $Z_Q = 50 \ \Omega$, $t_f \leq 2.5 \ ns$, $t_f \leq 2.5 \ ns$.
- D. The outputs are measured one at a time with one input transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms

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PACKAGING INFORMATION

Orderable part number	Status	Material type	Package Pins	Package qty Carrier	RoHS	Lead finish/	MSL rating/	Op temp (°C)	Part marking
	(1)	(2)			(3)	Ball material	Peak reflow		(6)
						(4)	(5)		
SN74ACT533DW	Active	Production	SOIC (DW) 20	25 TUBE	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	ACT533
SN74ACT533DW.A	Active	Production	SOIC (DW) 20	25 TUBE	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	ACT533
SN74ACT533N	Active	Production	PDIP (N) 20	20 TUBE	Yes	NIPDAU	N/A for Pkg Type	-40 to 85	SN74ACT533N
SN74ACT533N.A	Active	Production	PDIP (N) 20	20 TUBE	Yes	NIPDAU	N/A for Pkg Type	-40 to 85	SN74ACT533N
SN74ACT533PW	Obsolete	Production	TSSOP (PW) 20	-	-	Call TI	Call TI	-40 to 85	AD533
SN74ACT533PWR	Active	Production	TSSOP (PW) 20	2000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	AD533
SN74ACT533PWR.A	Active	Production	TSSOP (PW) 20	2000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	AD533

⁽¹⁾ Status: For more details on status, see our product life cycle.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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⁽³⁾ RoHS values: Yes, No, RoHS Exempt. See the TI RoHS Statement for additional information and value definition.

⁽⁴⁾ Lead finish/Ball material: Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

⁽⁵⁾ MSL rating/Peak reflow: The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

⁽⁶⁾ Part marking: There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.



PACKAGE OPTION ADDENDUM

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PACKAGE MATERIALS INFORMATION

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TAPE AND REEL INFORMATION





A0	Dimension designed to accommodate the component width
В0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74ACT533PWR	TSSOP	PW	20	2000	330.0	16.4	6.95	7.0	1.4	8.0	16.0	Q1

PACKAGE MATERIALS INFORMATION

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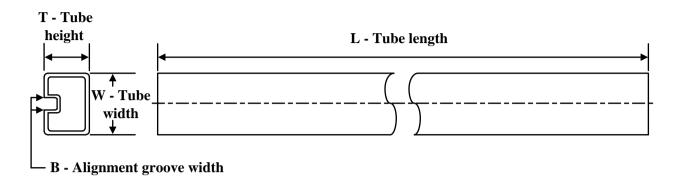
*All dimensions are nominal

Г	Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)	
Г	SN74ACT533PWR	TSSOP	PW	20	2000	353.0	353.0	32.0	

PACKAGE MATERIALS INFORMATION

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TUBE



*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (µm)	B (mm)
SN74ACT533DW	DW	SOIC	20	25	507	12.83	5080	6.6
SN74ACT533DW.A	DW	SOIC	20	25	507	12.83	5080	6.6
SN74ACT533N	N	PDIP	20	20	506	13.97	11230	4.32
SN74ACT533N.A	N	PDIP	20	20	506	13.97	11230	4.32

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